



D5V0P4B5LP08

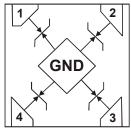
4 CHANNEL BI-DIRECTIONAL TVS ARRAY

Features

- Provides ESD Protection per IEC 61000-4-2 Standard: Air ±15kV, Contact ±15kV
- 4 Channel of ESD Protection
- Low Channel Input Capacitance of 4.8pF Typical
- IEC 61000-4-5 (Surge): 3A (tp = 8x20µs)
- Ultra Low Leakage Current 100nA (max)
- Typically Used in Cellular Handsets, Portable Electronics, Communication Systems, Computers and Peripherals
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: X2-DFN0808-4
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish NiPdAu annealed over Copper leadframe.
 Solderable per MIL-STD-202, Method 208 4
- Weight: 0.0015 grams (Approximate)



Top View Pin Configuration

Ordering Information (Note 4)

Product	Compliance	Marking	Reel size(inches)	Tape width(mm)	Quantity per reel
D5V0P4B5LP08-7	Standard	SB	7	8	10,000/Tape & Reel

Notes

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



SB = Product Type Marking Code



Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P_{PP}	40	W	8/20µs
Peak Pulse Current	I _{PP}	3	Α	8/20µs
ESD Protection – Contact Discharge	V _{ESD_Contact}	±15	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	V_{ESD_Air}	±15	kV	IEC 61000-4-2 Standard

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P _D	300	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ heta JA}$	417	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	V_{RWM}	_	_	±5.5	V	_
Leakage Current (Note 6)	I _{RM}	_	_	100	nA	V _{RWM} = 5V
Clamping Voltage from Data Pin to GND	V _{CL1}	_	10 13	_	V	$I_{PP} = 1A, t_p = 8/20\mu S$ $I_{PP} = 3A, t_p = 8/20\mu S$
Clamping Voltage from GND to Data Pin	V _{CL2}	_	9 13	_	V	$I_{PP} = 1A, t_p = 8/20\mu S$ $I_{PP} = 3A, t_p = 8/20\mu S$
Dynamic Resistance	R _{DYN}	_	0.45 0.42	_	Ω	Pins to GND (Note 7) GND to Pins (Note 7)
IO Capacitance	C _{IO}	_	4.8	7	pF	V _{IO} = 2.5V, f = 1MHz
Breakdown Voltage from Data Pin to GND	V _{BRF}	6	_	_	V	I _R = 1mA
Breakdown Voltage from GND to Data Pin	V_{BRR}	6	_	_	V	I _R = 1mA

Notes:

- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.
- 6. Short duration pulse test used to minimize self-heating effect.
- 7. Extraction of RDYN using least squares fit of TLP between I = 10A and I = 20A.

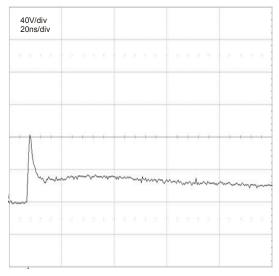


Figure 1 IEC 6100-4-2 Clamping Voltage +8kV Contact

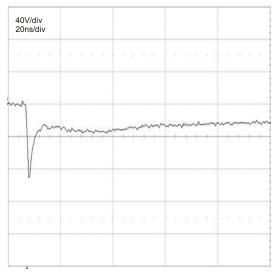
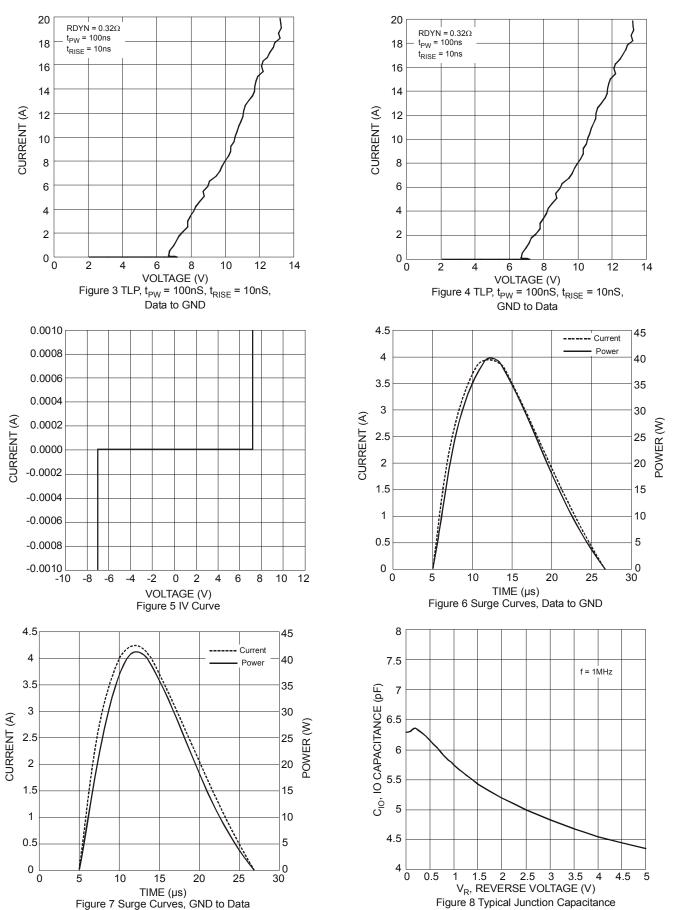
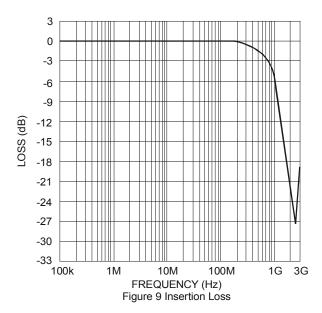


Figure 2 IEC 6100-4-2 Clamping Voltage -8kV Contact



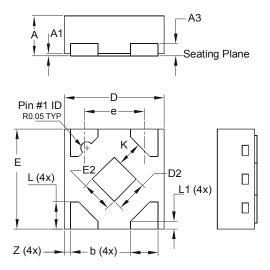






Package Outline Dimensions

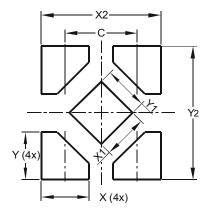
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



X2-DFN0808-4						
Dim	Min	Max	Тур			
Α	0.25	0.35	0.30			
A1	0	0.04	0.02			
A3	-	-	0.13			
b	0.17	0.27	0.22			
D	0.75	0.85	0.80			
D2	0.15	0.35	0.25			
Е	0.75	0.85	0.80			
E2	0.15	0.35	0.25			
е	ı	ı	0.48			
K	0.20	-	-			
L	0.17	0.27	0.22			
L1	0.02	0.12	0.07			
Z	-	-	0.05			
All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value		
Dillielisions	(in mm)		
С	0.480		
Х	0.320		
X1	0.300		
X2	0.800		
Υ	0.320		
Y1	0.300		
Y2	0.900		



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